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Docket No.: 2336-086

· PATENT

INTHE LINTED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	
	:	G (2)
Jeong-Goo YOON et al.	:	Confirmation No. 9603

U.S. Patent Application No. 10/006,143 : Group Art Unit: 2823

Filed: December 10, 2001 : Examiner: G. Fourson III

For: PROCESS FOR LAPPING WAFER AND METHOD FOR PROCESSING BACKSIDE OF WAFER

USING THE SAME

Dear Sir:

Transmitted herewith is an Amendment in the above identified application.

\boxtimes	No additional fee is required.
	Small entity status of this application has been established

The fee has been calculated as shown below:

Also attached: Exhibits A-C

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	14	20	0	x \$ 18 =	\$ 0.00
Independent Claims	3	3	0	x \$ 86 =	\$ 0.00
	If multiple claims newly presented, add \$290.00			n/a	
Fee for extension of time			n/a		
			Ţ	TOTAL FEE DUE	\$ 0.00

The Commissioner is hereby authorized to charge payment of any fees associated with this communication
 or credit any overpayment, to Deposit Account No. 07-1337, including any filing fees under 37 CFR 1.16
for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

A credit card authorization form in the amount of ______ is attached

Respectfully submitted,

LOWE HAUPTMAN GILMAN & BERNER, LLP

Benjamin J. Hauptman Registration No.: 29,310

USPTO Customer No. 22429 1700 Diagonal Road, Suite 300 Alexandria, Virginia 22314 (703) 684-1111 BJH/klb (703) 518-5499 Facsimile Date: January 7, 2004 Docket No.: 2336-086 PATENT

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For: PROCESS FOR LAPPING WAFER AND METHOD FOR PROCESSING BACKSIDE

OF WAFER USING THE SAME

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria VA 22313-1450

Sir:

The following amendments and remarks are submitted in response to the Official Action dated *October 7, 2003*.